

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1 (currently amended): A nonvolatile semiconductor memory package comprising:

a memory device having a memory cell array including a plurality of nonvolatile semiconductor memory cells;

a control portion configured to control the memory device;

a network interface connectable to a network;

a file management portion connected to the network interface and configured to manage a relationship between a data file from the network and an address of the memory cell array; and

a memory interface connected to the file management portion and configured to convert a signal from the ~~network~~ file management portion to a signal which is capable of being used at the control portion,

wherein the package is wrapped by an insulating material.

2 (original): The nonvolatile semiconductor memory package according to claim 1, wherein the network interface corresponds to a transmission control protocol/internet protocol.

3 (original): The nonvolatile semiconductor memory package according to claim 2, wherein the network interface is connectable to the network by using a file transfer protocol.

4 (original): The nonvolatile semiconductor memory package according to claim 2, wherein the network interface is connectable to the network by using an anonymous file transfer protocol.

5 (original): The nonvolatile semiconductor memory package according to claim 2, wherein the network interface is connectable to the network by using a point-to-point protocol.

6 (original): The nonvolatile semiconductor memory package according to claim 1, wherein the package is also connectable to equipment disconnected from the network.

7 (previously presented): The nonvolatile semiconductor memory package according to claim 6, wherein the package functions as a storage device for the equipment.

8 (currently amended): A detachable memory device comprising:

- a memory device having a memory cell array including a plurality of nonvolatile semiconductor memory cells;

- a control portion configured to control the memory device;

- a network interface connectable to a network;

- a file management portion connected to the network interface and configured to manage a relationship between a data file from the network and an address of the memory cell array; and

- a memory interface connected to the file management portion and configured to convert a signal from the ~~network~~ file management portion to a signal which is capable of being used at the control portion.

9 (previously presented): The detachable memory device according to claim 8, wherein the network interface corresponds to a transmission control protocol/internet protocol.

10 (previously presented): The detachable memory device according to claim 8, wherein the network interface is connectable to the network by using a file transfer protocol.

11 (previously presented): The detachable memory device according to claim 8, wherein the network interface is connectable to the network by using an anonymous file transfer protocol.

12 (previously presented): The detachable memory device according to claim 8, wherein the network interface is connectable to the network by using a point-to-point protocol.

13 (currently amended): The detachable memory device according to claim 8, wherein the ~~package~~ detachable memory device is also connectable to equipment disconnected from the network.

14 (currently amended): The detachable memory device according to claim 13, wherein the package detachable memory device functions as a storage device for the equipment.

15 (new): The nonvolatile semiconductor memory package according to claim 1, wherein the memory cell array includes a NAND type memory cell unit.

16 (new): The detachable memory device according to claim 8, wherein the memory cell array includes a NAND type memory cell unit.

17 (new): The nonvolatile semiconductor memory package according to claim 1, further comprising a power source unit.

18 (new): The detachable memory device according to claim 8, further comprising a power source unit.

19 (new): The nonvolatile semiconductor memory package according to claim 1, wherein the nonvolatile semiconductor memory package is connectable to a download machine to hold software from a data server linked with the download machine via the network.

20 (new): The detachable memory device according to claim 8, wherein the detachable memory device is connectable to a download machine to hold software from a data server linked with the download machine via the network.